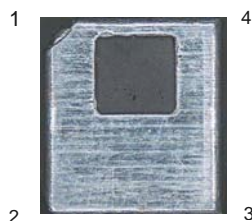
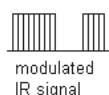


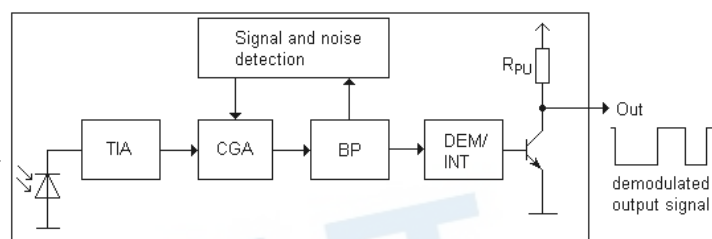
Infrared Receiver Module IRM-H2XXT/TR2 Series



1. GND
2. OUT
3. Vcc
4. GND



Block Diagram



Features

- High protection ability against EMI
 - Available for various carrier frequencies
 - Min burst length: 12 cycles
 - Min gap length: 16 cycles
- Low operating voltage and low power consumption
- High immunity against ambient light
- Long reception range
- High sensitivity
- Pb free and RoHS compliant
- Compliance with EU REACH
- Compliance Halogen Free (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)

Descriptions

The device is a miniature SMD type infrared remote control system receiver that has been developed and designed by utilizing the most updated IC technology.

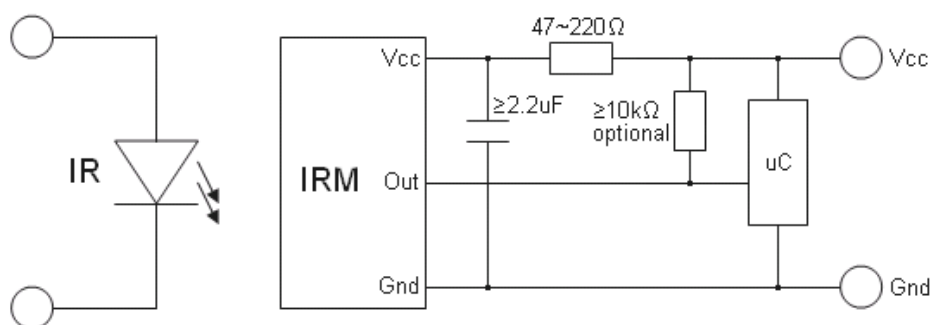
The PIN diode and preamplifier are assembled on PCB, the epoxy package is designed as an IR filter.

The demodulated output signal can directly be decoded by a microprocessor.

Applications

- .Optical switch
- .Light detecting portion of remote control
- .AV instruments such as Audio, TV, VCR, CD, MD, etc.
- .Home appliances such as Air-conditioner, Fan , etc.
- .The other equipments with wireless remote control.
- .CATV set top boxes
- .Multi-media Equipment

Application Circuit



RC Filter should be connected closely between Vcc pin and GND pin.

Parts Table

Model No.	Carrier Frequency
IRM-H236T/TR2	36 kHz
IRM-H238T/TR2	38 kHz

Absolute Maximum Ratings (Ta=25°C) *1

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	6	V
Operating Temperature	Topr	-20 ~ +80	°C
Storage Temperature	Tstg	-40 ~ +85	°C
Soldering Temperature*2	Tsol	260	°C

*1 Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

*2 Soldering time \leq 5 seconds

Electro-Optical Characteristics (Ta=25°C, Vcc=3V)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Supply Current	Icc	---	0.4	0.7	mA	No signal input
Supply Voltage	Vcc	2.7	---	5.5	V	
Peak Wavelength	λ_p	---	940	---	nm	---
Reception Distance	L ₀	8	---	---	m	See chapter 'Test method' *3
	L ₄₅	5	---	---		
Half Angle (Horizontal)	Θ_h	---	± 45	---	deg	
Half Angle (Vertical)	Θ_v	---	± 45	---	deg	
High Level Pulse Width	T _H	400	---	800	μ s	Test signal according to figure 1 *4
Low Level Pulse Width	T _L	400	---	800	μ s	
High Level Output Voltage	V _H	Vcc-0.4	---	---	V	I _{SOURCE} \leq 1 μ A
Low Level Output Voltage	V _L	---	0.2	0.5	V	I _{SINK} \leq 2mA

*3 The ray receiving surface at a vertex and relation to the ray axis in the range of $\theta=0^\circ$ and $\theta=45^\circ$.

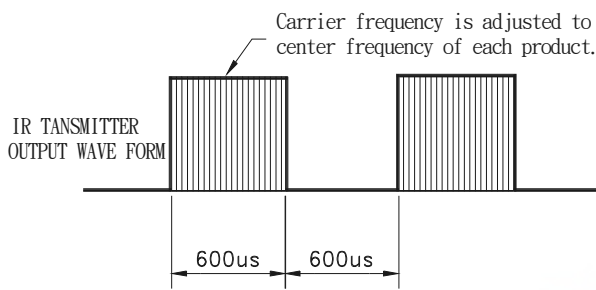
*4 A range from 30cm to the arrival distance. Average value of 50 pulses.

Test Method

The specified electro-optical characteristic is satisfied under the following Conditions:

1. Measurement environment
A place without extreme light reflected
2. External light
Ordinary white fluorescent lamps (Light source temperature 2856°K, $E_e \leq 10\text{Lux}$) without high frequency modulation
3. Standard transmitter
The test transmitter is calibrated by using the circuit shown in figure 2. The radiation intensity of the transmitter is adjusted until **$V_o=400\text{mVp-p}$** . Both, the test transmitter and the photo diode, have a peak wavelength of 940nm. The photo diode for calibration is PD438B ($\lambda_p=940\text{nm}$, $V_r=5\text{V}$).
4. Measuring system According to the measuring system shown in Fig.-3

Fig.-1 Transmitter Wave Form



D.U.T output Pulse

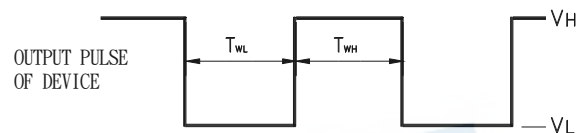


Fig.-2 Measuring Method

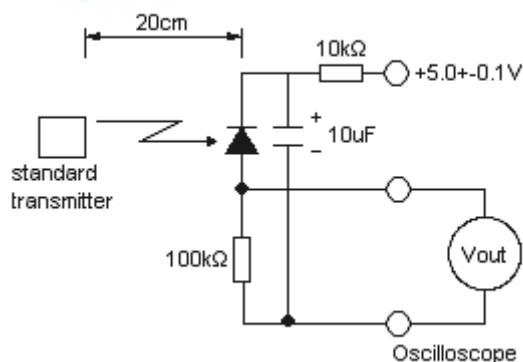
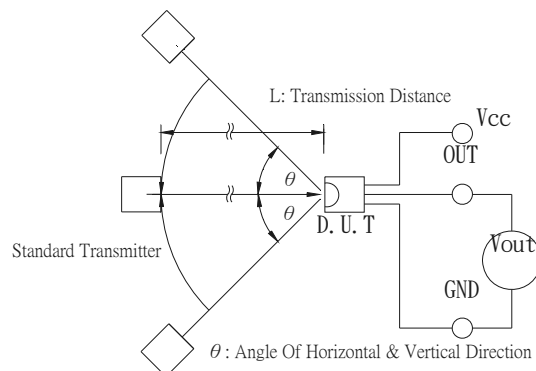


Fig.-3 Measuring System



Typical Electro-Optical Characteristics Curves

Fig.-4 Relative Spectral Sensitivity vs. Wavelength

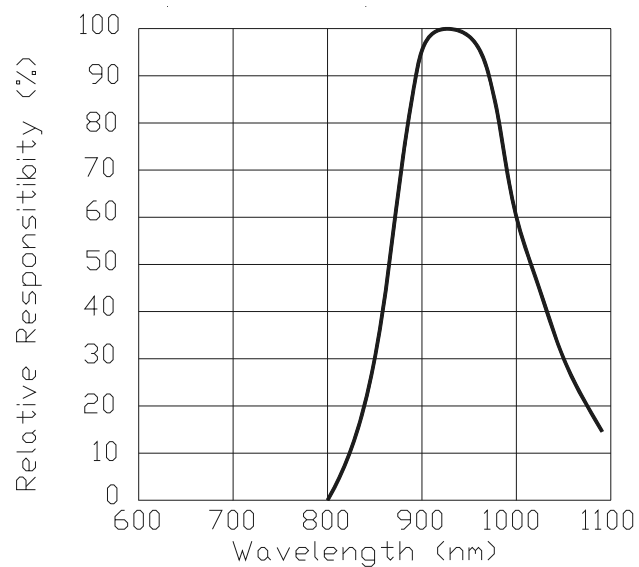


Fig.-5 Relative Transmission Distance vs. Direction

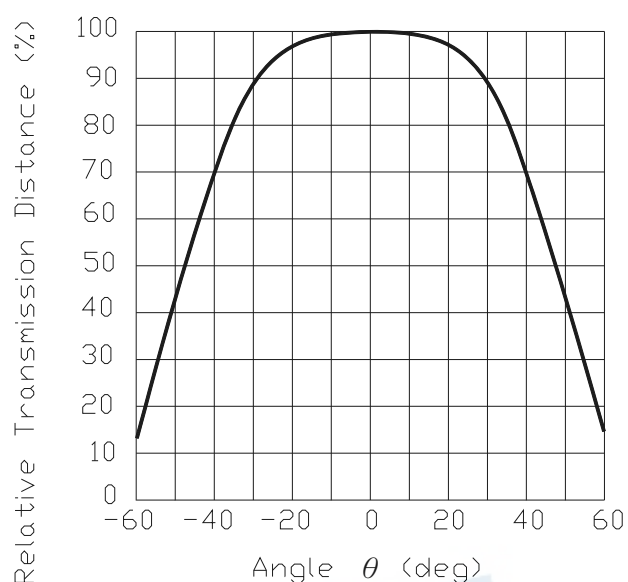


Fig.-6 Output Pulse Length vs. Arrival Distance

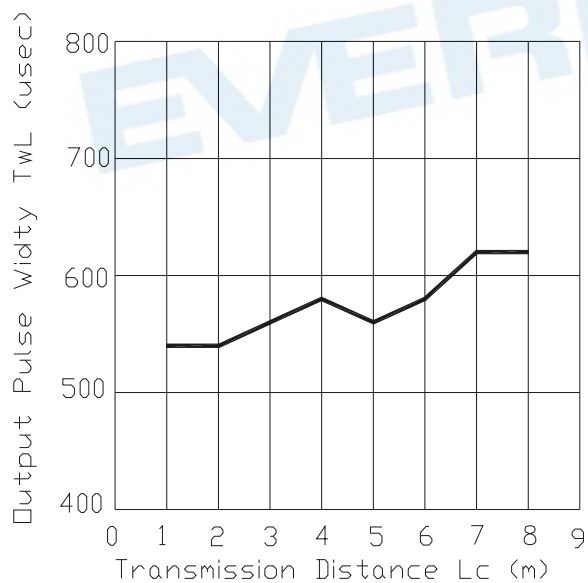
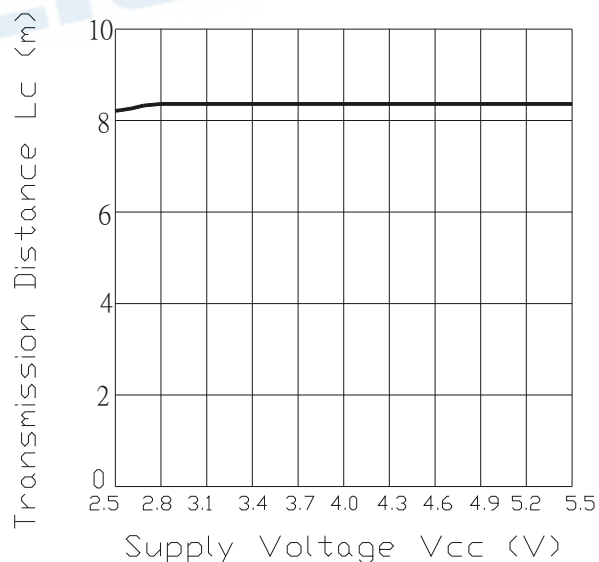


Fig.-7 Arrival Distance vs. Supply Voltage



Typical Electro-Optical Characteristics Curves

Fig.- 8 Relative Transmission Distance vs.
Center Carrier Frequency – 36 KHz

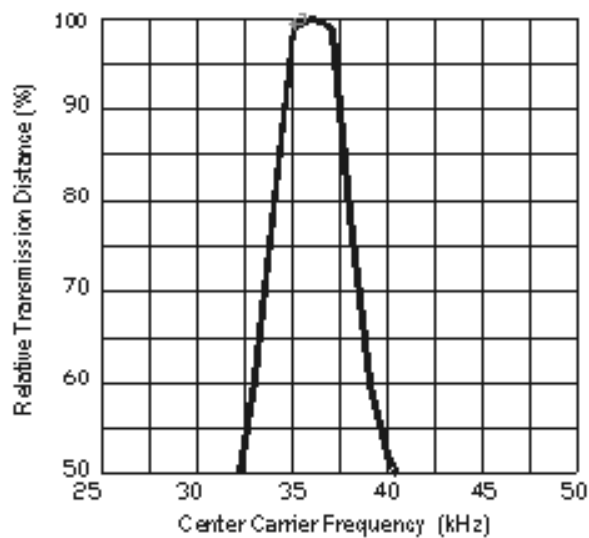
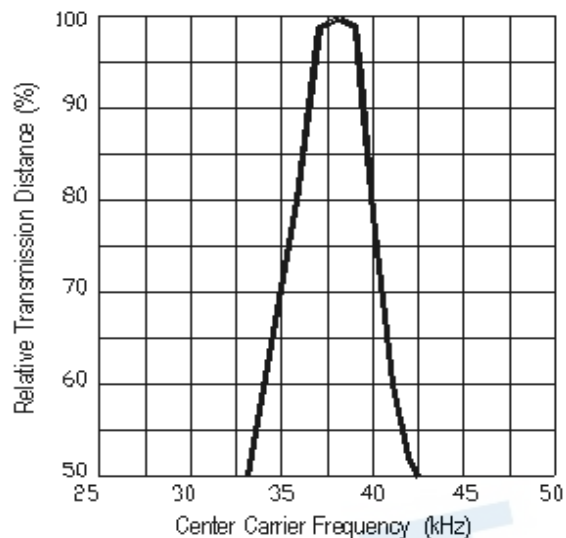
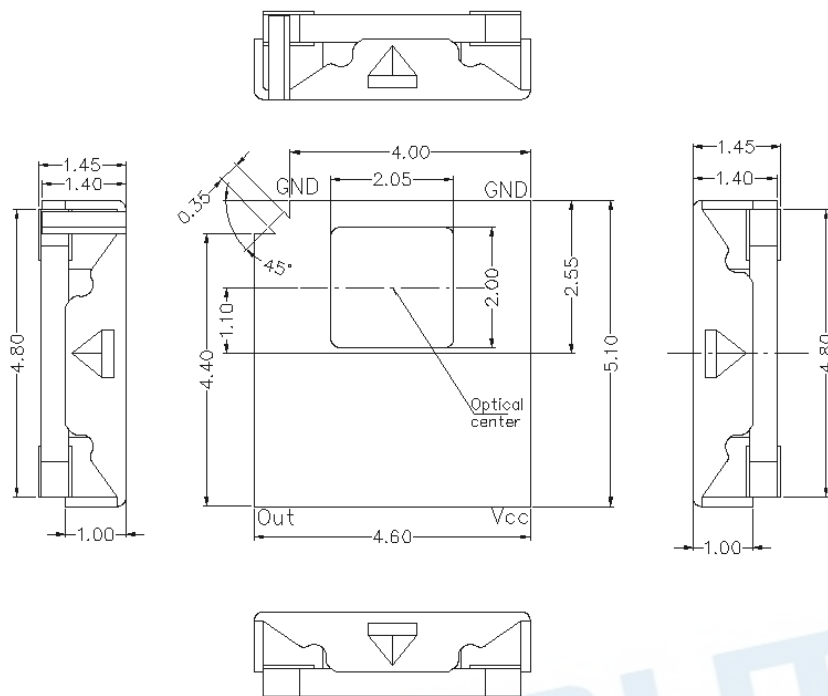


Fig.- 9 Relative Transmission Distance vs.
Center Carrier Frequency – 38 KHz

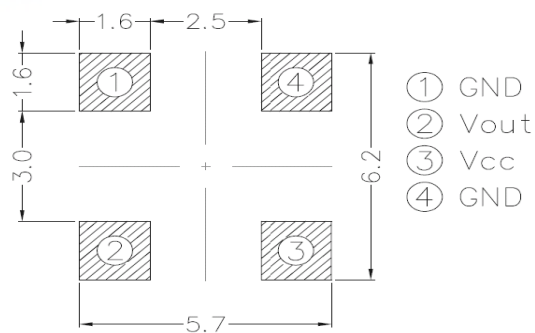


Package Dimenstions
(Dimensions in mm)



Note: Tolerances unless mentioned $\pm 0.5\text{mm}$. Unit: mm

Recommended pad layout for surface mount leadform



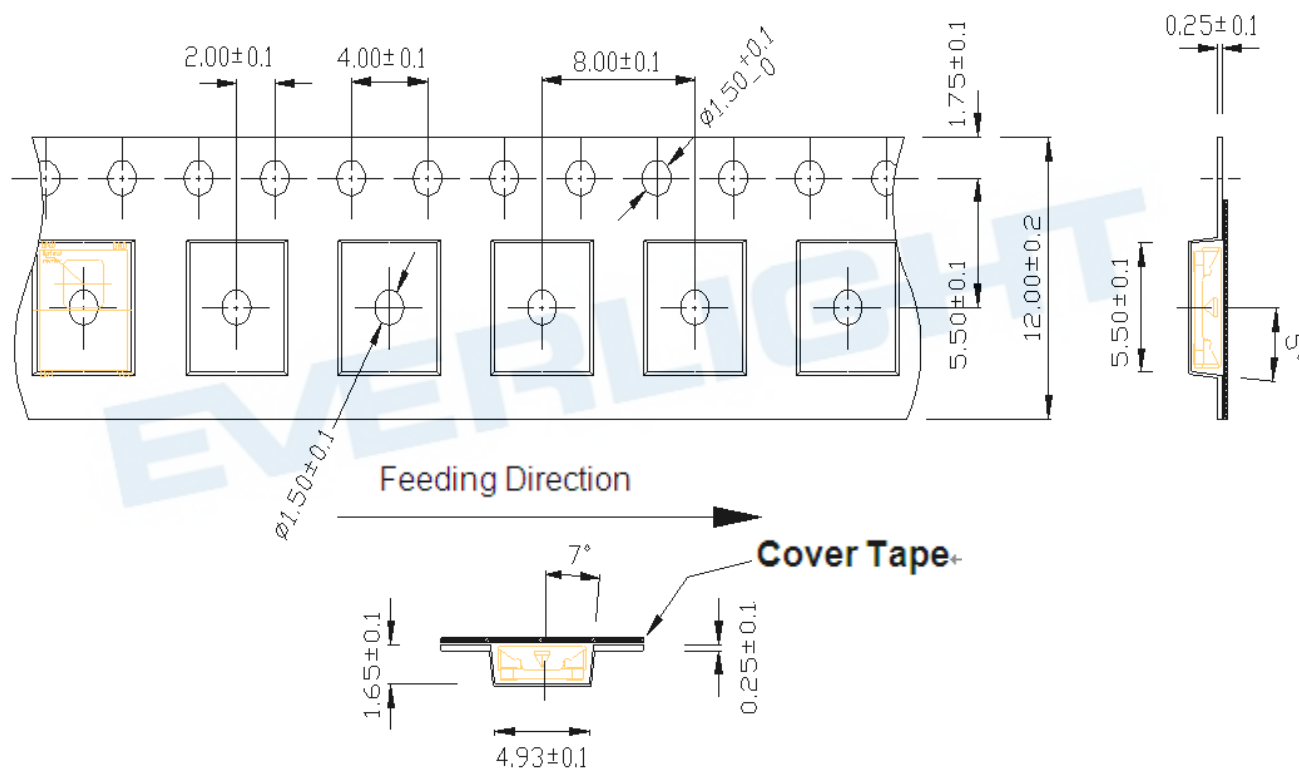
Notice: Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Code information

Protocol	Suitable	Protocol	Suitable
Matsushita	Yes	Sony 12 bit	Yes
NEC	Yes	Sony 15 bit	No
RC5	Yes	Sony 20 bit	No
RC6 ¹⁾	Yes	Sharp	Yes
Toshiba	Yes	Zenith	Yes
RCA	No	Continuous Code	No

1) RC6 is only compatible if the data low time is 25ms or more.

Tape & Reel Packing Specifications



Packing Quantity

4000 pcs / Reel
3 Reels / Boxes
5 Boxes / Carton

Recommended method of storage

The following are general recommendations for moisture sensitive level (MSL) 4 storage and use:

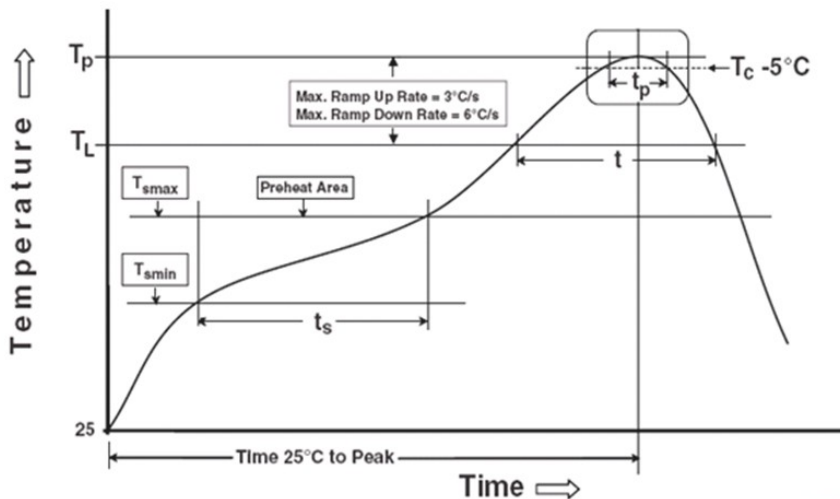
1. Do not open moisture proof bag before devices are ready to use.
2. Shelf life in sealed bag from the bag seal date: 12 months at 10°C~30°C and < 90% RH.
3. After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within 72 hours (floor life).
4. If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions: 96 hours at 60°C ± 5°C and < 5 % RH.

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ESD Precaution

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Anti-static bag. Electro-Static Sensitive Devices warning labels are on the packing.

Solder Reflow Temperature Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_p)	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	2 times

Note:

1. Reflow soldering should not be done more than two times.
2. When soldering, do not put stress on the IRM device during heating.
3. After soldering, do not warp the circuit board.

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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6. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.

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